


**PRODUCT / PROCESS CHANGE INFORMATION**

**1. PCI basic data**

<b>1.1 Company</b>		STMicroelectronics International N.V
<b>1.2 PCI No.</b>	ADG/19/11691	
<b>1.3 Title of PCI</b>	TOP3 Mold cavity identity change	
<b>1.4 Product Category</b>	BTW69 / BTW68 / BTA26xx / BTA41xxx / BTB26xxx BTB41xxx / TPDVxxx / TNxxx-12PI / STTHxxxPI STPS3045CPIRG / STPSCxxxPI	
<b>1.5 Issue date</b>	2019-07-19	

**2. PCI Team**

<b>2.1 Contact supplier</b>	
<b>2.1.1 Name</b>	FRANCKE CHRISTIANE
<b>2.1.2 Phone</b>	+49 89460062128
<b>2.1.3 Email</b>	christiane.francke@st.com
<b>2.2 Change responsibility</b>	
<b>2.2.1 Product Manager</b>	Richard RENARD
<b>2.1.2 Marketing Manager</b>	Philippe LEGER
<b>2.1.3 Quality Manager</b>	Jean-Paul REBRASSE

**3. Change**

<b>3.1 Category</b>	<b>3.2 Type of change</b>	<b>3.3 Manufacturing Location</b>
Methods	Standard inner labelling	Subcontractor in Philippines

**4. Description of change**

	Old	New
<b>4.1 Description</b>	The purpose of this change is to improve the traceability and the quality of the TOP3 / DOP3 packaged product, as well to provide a further way to identify and prevent fake products.	After change : Cavity ID will be codified on 3 confidential digits A new visual identification the cavity of the product package.
<b>4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?</b>	no impact	

**5. Reason / motivation for change**

<b>5.1 Motivation</b>	improve traceability
<b>5.2 Customer Benefit</b>	SERVICE IMPROVEMENT

**6. Marking of parts / traceability of change**

<b>6.1 Description</b>	Before change : Cavity ID was "PHIL" After change : Cavity ID will be codified on 3 confidential digits
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**7. Timing / schedule**

<b>7.1 Date of qualification results</b>	2019-07-19
<b>7.2 Intended start of delivery</b>	2019-08-19
<b>7.3 Qualification sample available?</b>	Not Applicable

**8. Qualification / Validation**

<b>8.1 Description</b>			
<b>8.2 Qualification report and qualification results</b>	In progress	<b>Issue Date</b>	

**9. Attachments (additional documentations)**

11691 Public product.pdf  
11691 PCI-TOP3.doc

**10. Affected parts**

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STTH3002PI	
	TPDV840RG	

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